CLAIMS

1. A substrate arrangement assisting jig comprising:

a plate-shaped jig main body that has a plurality of standby holes in which substrates are arrangeable; and

claw portions that are provided on the jig main body, protrude from at least one position on an edge of each of the standby holes, and hold the substrates while being in contact with outer circumferential ends of the substrates,

wherein the claw portions are configured to freely protrude into or retract from regions of the standby holes.

2. The substrate arrangement assisting jig according to claim 1,

wherein the claw portions are provided at two or more positions on a circumferential surface of each of the standby holes,

the claw portions each have an inclined surface that is configured not to come into contact with main surfaces of a corresponding one of the substrates and is configured to come into contact with a chamfered surface that is provided at an outer circumferential end of the corresponding substrate, and

the substrates are held in the respective standby holes as a result of each claw portion supporting a corresponding one of the substrates from below with the inclined surface being in contact with the chamfered surface.

3. The substrate arrangement assisting jig according to claim 1,

wherein the claw portions each include a projecting portion that projects inward from an edge of a corresponding one of the standby holes and abuts against a side wall surface that is provided at an outer circumferential end of a corresponding one of the substrates and is perpendicular to main surfaces of the corresponding substrate, and

the substrates are held in the respective standby holes as a result of the projecting portion abutting against the side wall surface from a direction

perpendicular to the side wall surface and pressing the corresponding substrate against a wall of the corresponding standby hole.

4. The substrate arrangement assisting jig according to any one of claims 1 to 3,

wherein the claw portions provided in the respective standby holes are configured to retract simultaneously with each other.

5. The substrate arrangement assisting jig according to any one of claims 1 to 4,

wherein a surface of the jig main body is provided with a positioning portion comprising a projection or a hole.

6. A method for producing substrates that includes polishing processing for polishing main surfaces of the substrates in a state where the substrates are held respectively in a plurality of substrate holding holes that are provided in a carrier, the method comprising:

in a state where the substrates are held respectively in the standby holes in the substrate arrangement assisting jig according to any one of claims 1 to 5 by the claw portions protruding from edges of the standby holes, retracting the claw portions of the jig main body at a position above the carrier, to release the substrates from the standby holes and cause the substrates to fall and be arranged respectively in the substrate holding holes in the carrier located below, and

polishing the substrates arranged in the carrier.